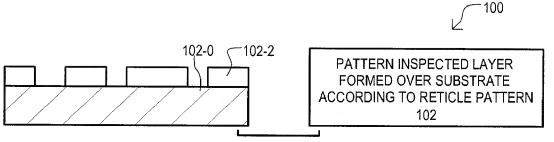

FIG. 1A

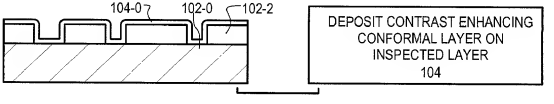

FIG. 1B

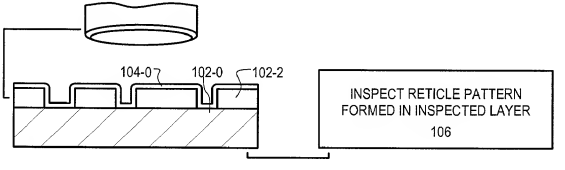

FIG. 1C

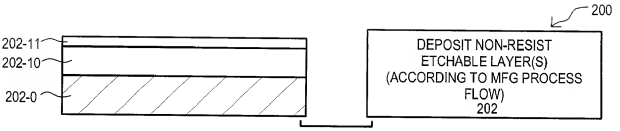

FIG. 2A

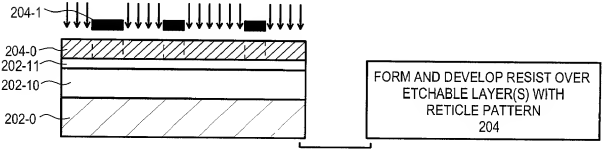

FIG. 2B

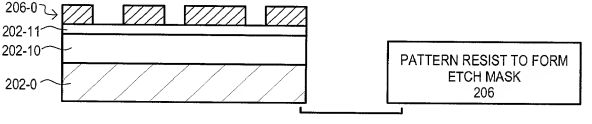

FIG. 2C

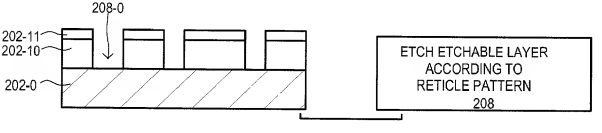

FIG. 2D

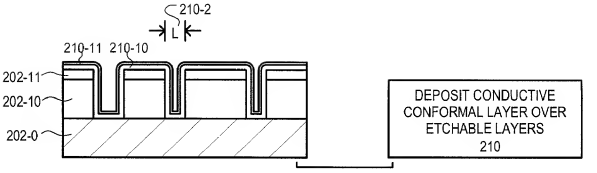
210-2
L
210-11
210-10
202-11
202-10
202-0
DEPOSIT CONDUCTIVE CONFORMAL LAYER OVER ETCHABLE LAYERS
210

FIG. 2E

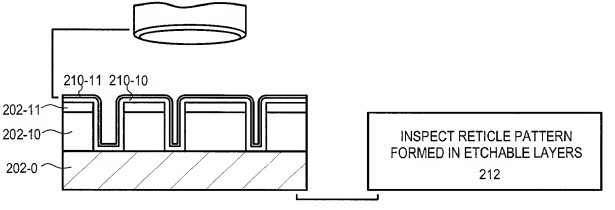
210-11
210-10
202-11
202-10
202-0
INSPECT RETICLE PATTERN FORMED IN ETCHABLE LAYERS
212

FIG. 2F

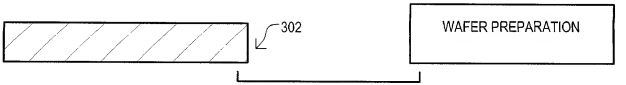

FIG. 3A

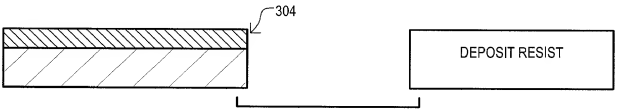

FIG. 3B

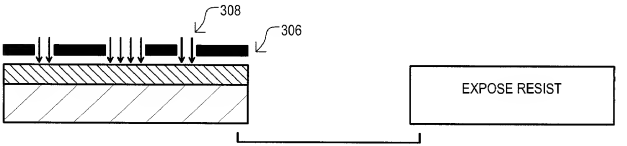

FIG. 3C

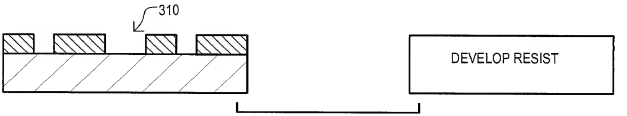

FIG. 3D

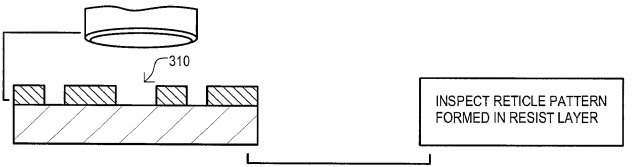

FIG. 3E